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14-stage Binary Counter



ADE-205-537 (Z) 1st. Edition Sep. 2000

#### Description

The HD74HC4060 is a 14 stage counter, this device increments on the falling edge (negative transition) of the input clock, and all their outputs are reset to a low level by applying a logical high on their reset input. The HD74HC4060 also has two additional inputs to enable easy connection of either an RC or crystal oscillator.

#### Features

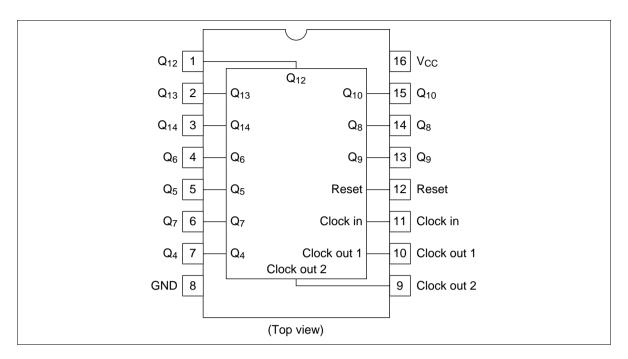
- High Speed Operation:  $t_{pd}$  (Clock to  $Q_4$ ) = 41.5 ns typ ( $C_L$  = 50 pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage:  $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low Input Current: 1 µA max
- Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max (Ta = 25°C)

## **Function Table**

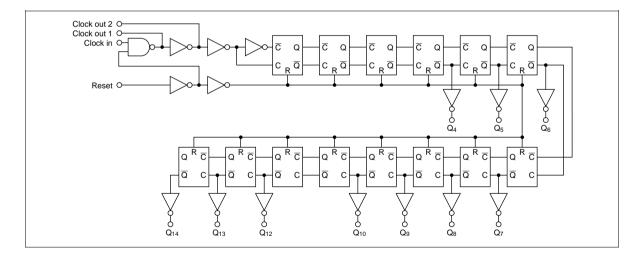
Clock in	Reset	Outputs State
	L	No change
	L	Advance to next state
Х	Н	All outputs are low

X : Irrelevant

## **Pin Arrangement**

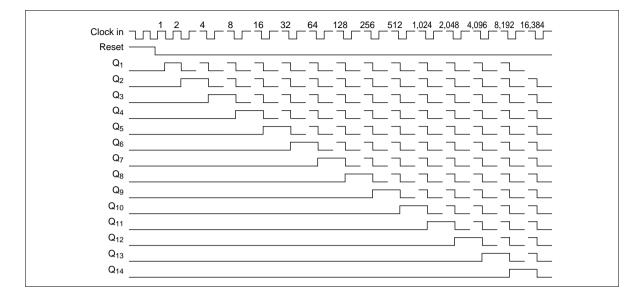


## **Block Diagram**





#### **Timing Diagram**





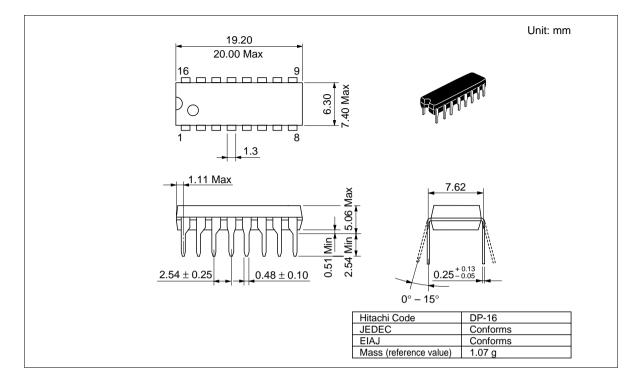
## **DC** Characteristics

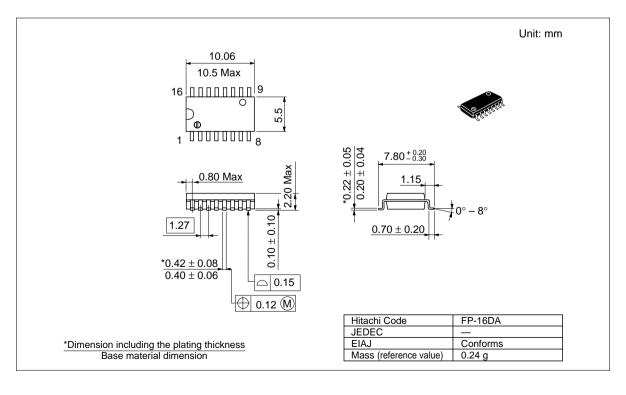
			Ta =	: 25°C	2	Ta = - +85°0	-40 to C			
ltem	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditio	ns
Input voltage	V <sub>IH</sub>	2.0	1.5			1.5	_	V		
		4.5	3.15	_	—	3.15	_	_		
		6.0	4.2	—	—	4.2	—			
	V <sub>IL</sub>	2.0		_	0.5	—	0.5	V		
		4.5	—	—	1.35	—	1.35			
		6.0		_	1.8	—	1.8	_		
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	_	1.9	—	V	$Vin = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA
		4.5	4.4	4.5	—	4.4	—	_		
		6.0	5.9	6.0	_	5.9	—	_		
		4.5	4.18		_	4.13	—	_		I <sub>он</sub> = -4 mА
		6.0	5.68		—	5.63	—	_		I <sub>он</sub> = -5.2 mА
	V <sub>OL</sub>	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \ \mu A$
		4.5	_	0.0	0.1	—	0.1	_		
		6.0	_	0.0	0.1	—	0.1	_		
		4.5		_	0.26		0.33	_		I <sub>oL</sub> = 4 mA
		6.0			0.26		0.33	_		I <sub>oL</sub> = 5.2 mA
Input current	lin	6.0			±0.1		±1.0	μΑ	$Vin = V_{cc} \text{ or } GI$	ND
Quiescent supply current	I <sub>cc</sub>	6.0	—		4.0	—	40	μΑ	$Vin = V_{cc} \text{ or } GI$	ND, lout = $0 \mu A$

			Ta = 25°C		Ta = –40 to +85°C				
ltem	Symbol	$V_{cc}$ (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	$f_{max}$	2.0	_	_	4	_	3	MHz	
frequency		4.5	—	—	20	—	16	_	
		6.0			24		19		
Propagation delay	t <sub>PLH</sub>	2.0	—	—	300		375	ns	Clock to Q <sub>4</sub>
time		4.5	—	42	60		75	_	
		6.0	—	—	51	—	63		
	t <sub>PHL</sub>	2.0	_	_	300		375	ns	Clock to Q <sub>4</sub>
		4.5	—	41	60	—	75		
		6.0	_	_	51	_	63		
	t <sub>PHL</sub>	2.0	_	_	240		300	ns	Reset to output
		4.5	—	16	48	—	60		
		6.0	—	—	41	—	51	_	
Removal time	t <sub>rem</sub>	2.0	100	_	_	125	_	ns	
		4.5	20	10	—	25	—		
		6.0	17	_	—	21	_	-	
Pulse width	t <sub>w</sub>	2.0	80			100		ns	
		4.5	16	7		20	—	-	
		6.0	14	_	_	17	_	_	
Output rise/fall	t <sub>TLH</sub>	2.0			75		95	ns	
time	t <sub>THL</sub>	4.5		5	15	_	19	=	
		6.0	_	_	13	_	16	-	
Input capacitance	Cin			5	10		10	pF	

## **AC Characteristics** ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

#### **Package Dimensions**





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